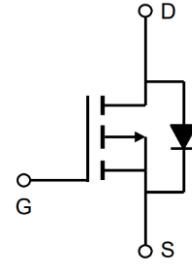


-18V P-Channel Enhancement Mode MOSFET

Description

The AP20P01BF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.



General Features

$V_{DS} = -18V$ $I_D = -20A$

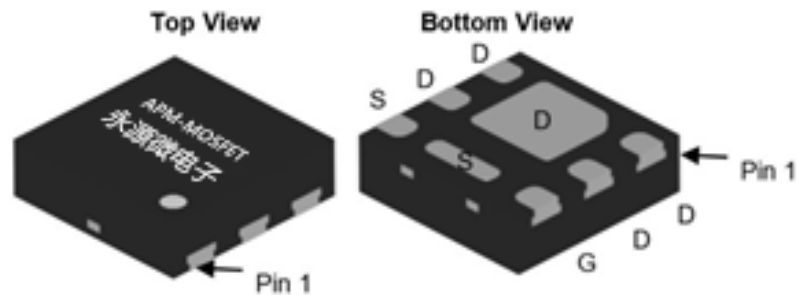
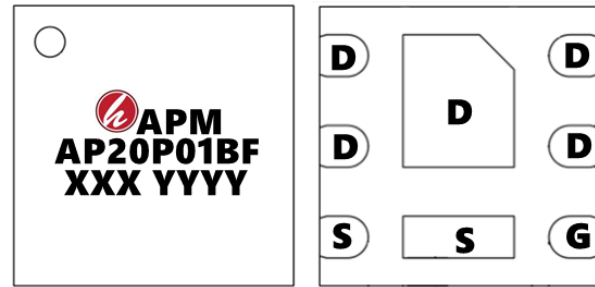
$R_{DS(ON)} < 18m\Omega$ @ $V_{GS}=10V$ (Type: 12m Ω)

$R_{DS(ON)} < 23m\Omega$ @ $V_{GS}=4.5V$ (Type: 14m Ω)

Application

Electronic cigarette

Load switch



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP20P01BF	DFN2*2-6L	AP20P01BF XXX YYYY	3000

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-Source Voltage	-18	V
V_{GSS}	Gate-Source Voltage	± 12	V
$I_D@T_C=25^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^1$	-20	A
$I_D@T_C=100^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^1$	-10.6	A
IDM	Pulsed Drain Current ^{note1}	-36	A
$P_D@T_C=25^\circ\text{C}$	Power Dissipation	1.6	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	$^\circ\text{C/W}$
TJ, TSTG	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

-18V P-Channel Enhancement Mode MOSFET

Electrical Characteristics (T_J=25°C, unless otherwise noted)

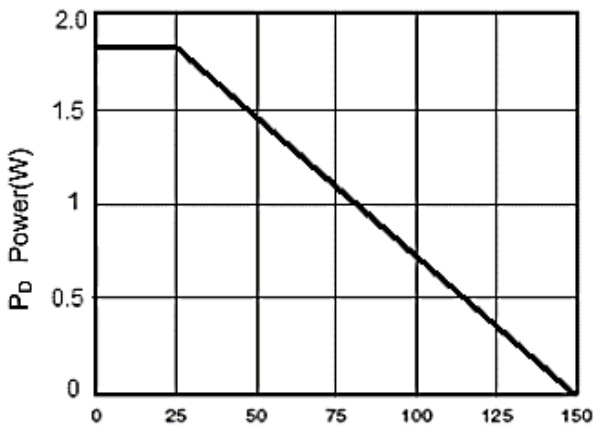
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-12	-18	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =-12V, V _{GS} =0V,	-	-	-1	μA
IGSS	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±12V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.5	-0.65	-1.0	V
RDS(on)	Static Drain-Source on-Resistance note2	V _{GS} =-10V, I _D =-6.0A	-	12	18	mΩ
RDS(on)	Static Drain-Source on-Resistance note2	V _{GS} =-4.5V, I _D =-5.2A	-	14	23	mΩ
RDS(on)	Static Drain-Source on-Resistance note2	V _{GS} =-2.5V, I _D =-4.2A	-	20	35	mΩ
C _{iss}	Input Capacitance	V _{DS} =-6V, V _{GS} =0V f=1.0MHz	-	1100	-	pF
C _{oss}	Output Capacitance		-	390	-	pF
C _{rss}	Reverse Transfer Capacitance		-	300	-	pF
Q _g	Total Gate Charge	V _{DS} =-4V, I _D =-4.1A, V _{GS} =-4.5V	-	11.5	-	nC
Q _{gs}	Gate-Source Charge		-	1.5	-	nC
Q _{gd}	Gate-Drain("Miller") Charge		-	3.2	-	nC
td(on)	Turn-on Delay Time	V _{DD} =-4V, I _D =-3.3A, R _G =1.0Ω, V _{GEN} =-4.5V, R _L =1.2Ω	-	25	-	ns
t _r	Turn-on Rise Time		-	45	-	ns
td(off)	Turn-off Delay Time		-	72	-	ns
t _f	Turn-off Fall Time		-	60	-	ns
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	-6.0	A
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-16	A
VSD	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =-4.1A	-	-	-1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V, I _S =-4.1A, di/dt=100A/μs	-	20	-	ns
Q _{rr}	Reverse Recovery Charge		-	9	-	nC

Note :

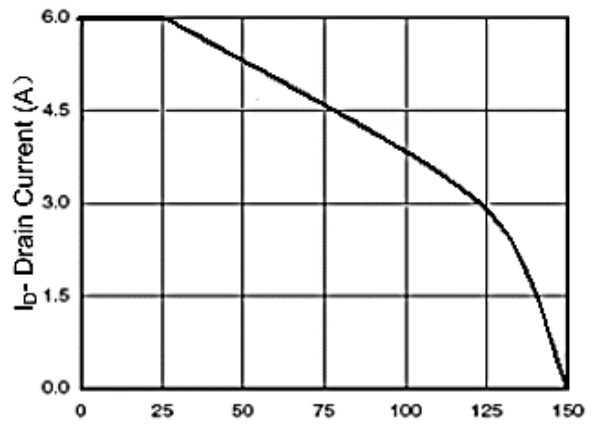
- 1、 The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width ≅ 300us , duty cycle ≅ 2%
- 3、 The power dissipation is limited by 150°C junction temperature
- 4、 The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

-18V P-Channel Enhancement Mode MOSFET

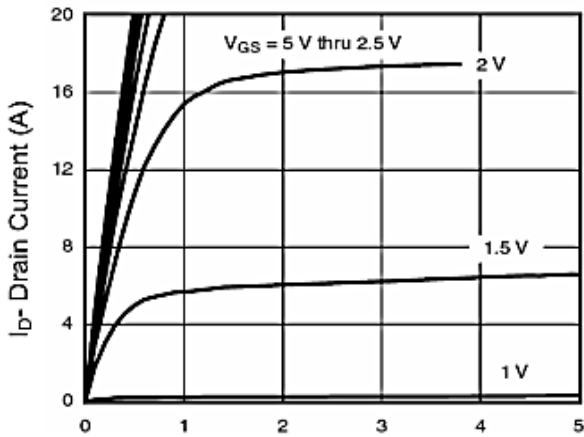
Typical Characteristics



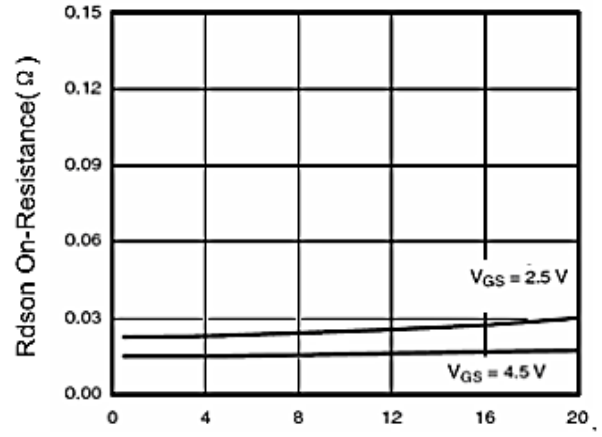
T_J-Junction Temperature(°C)
Figure 1 Power Dissipation



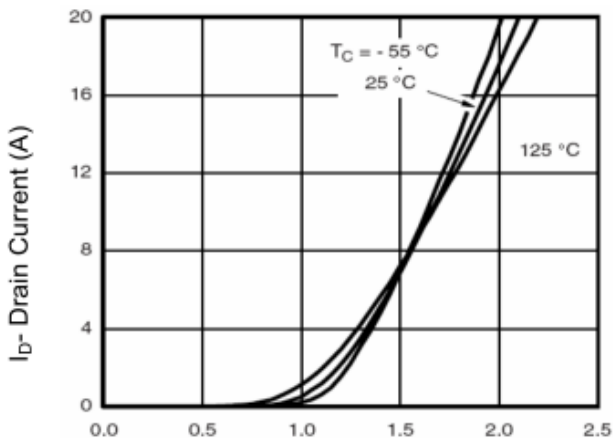
T_J-Junction Temperature(°C)
Figure 2 Drain Current



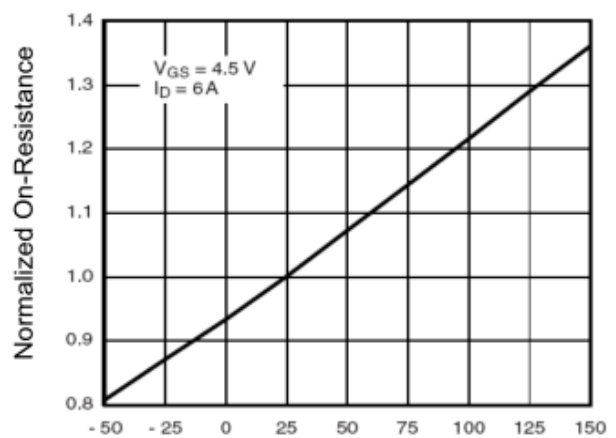
V_{GS} = 5 V thru 2.5 V
V_{GS} = 2 V
V_{GS} = 1.5 V
V_{GS} = 1 V
V_{DS} Drain-Source Voltage (V)
Figure 3 Output Characteristics



V_{GS} = 2.5 V
V_{GS} = 4.5 V
I_D- Drain Current (A)
Figure 4 Drain-Source On-Resistance

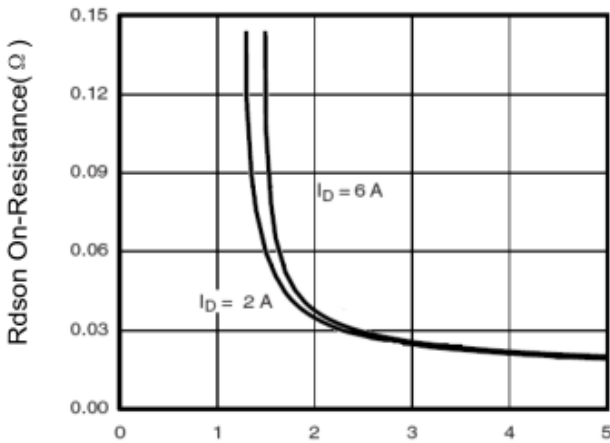


T_C = -55 °C
25 °C
125 °C
V_{GS} Gate-Source Voltage (V)
Figure 5 Transfer Characteristics

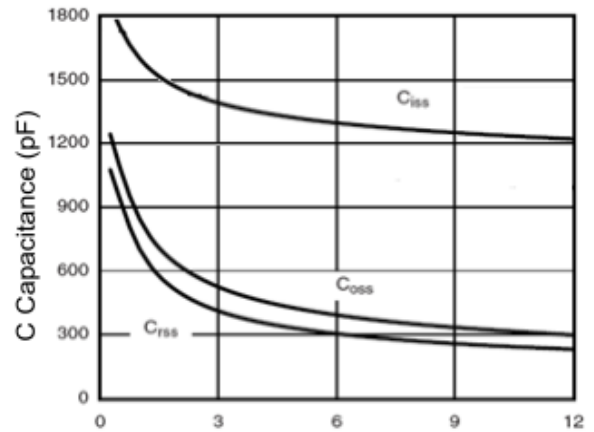


V_{GS} = 4.5 V
I_D = 6 A
T_J-Junction Temperature(°C)
Figure 6 Drain-Source On-Resistance

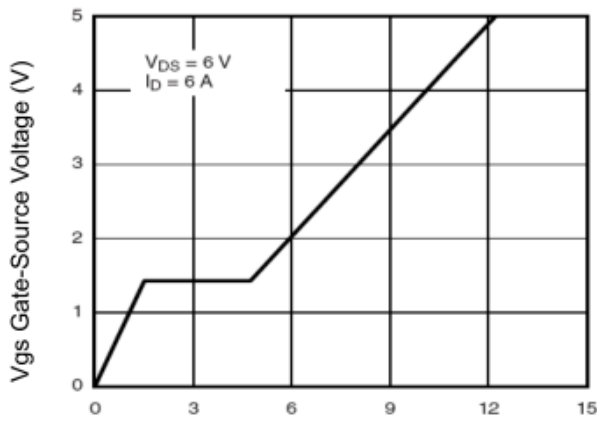
-18V P-Channel Enhancement Mode MOSFET



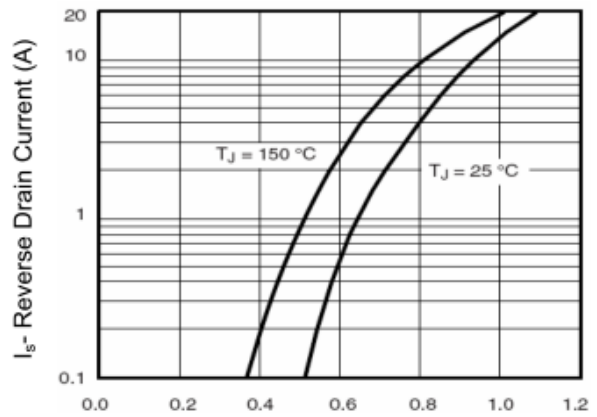
Vgs Gate-Source Voltage (V)
Figure 7 Rdson vs Vgs



Vds Drain-Source Voltage (V)
Figure 8 Capacitance vs Vds



Qg Gate Charge (nC)
Figure 9 Gate Charge



Vsd Source-Drain Voltage (V)
Figure 10 Source-Drain Diode Forward

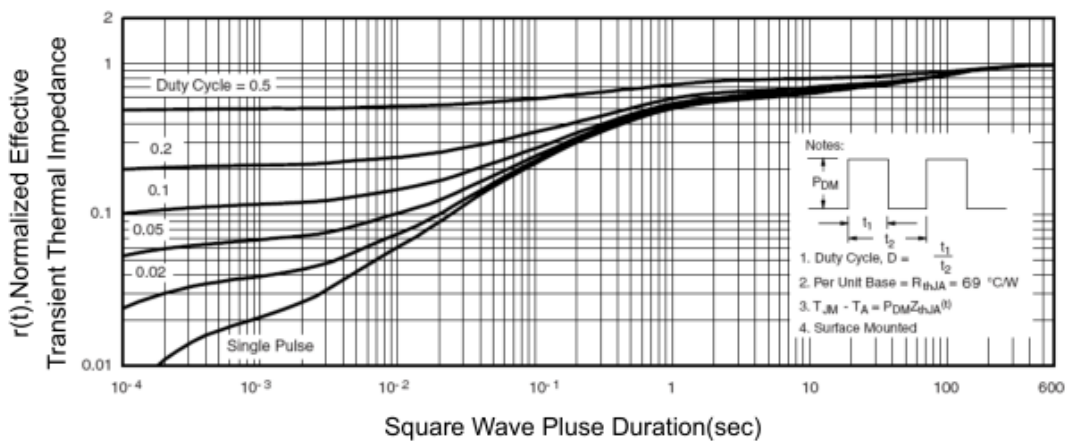
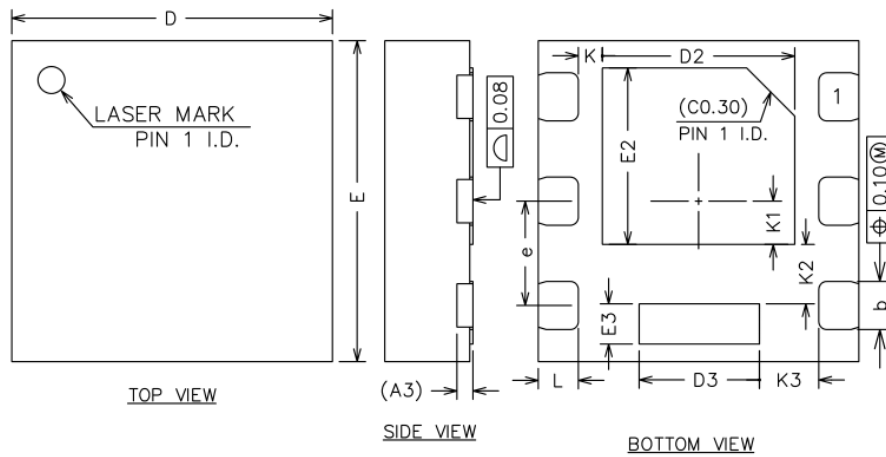


Figure 12 Normalized Maximum Transient Thermal Impedance

-18V P-Channel Enhancement Mode MOSFET

Package Mechanical Data: QFN2*2-6L



Symbol	Min	Nom	Max
	A	0.50	--
A1	0.00	0.02	0.05
A3	0.10REF		
b	0.25	0.30	0.35
D	1.90	2.00	2.10
E	1.90	2.00	2.10
D2	1.10	1.20	1.30
E2	1.00	1.10	1.20
D3	0.65	0.75	0.85
E3	0.15	0.25	0.35
e	0.55	0.65	0.75
K	0.05	--	--
K1	0.17	--	--
K2	0.27	--	--
K3	0.28	--	--
L	0.20	0.25	0.30

-18V P-Channel Enhancement Mode MOSFET Attention

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-18V P-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2020/9/8	Initial release

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